

THERMOPLASTIC MONO-MATERIAL SANDWICH PANELS

Manufacturing for aircraft interiors

Temuri Latsuzbaya







AGENDA

- About Diehl Aviation
- Object and concept
- Manufacturing process
- Numerical method
- Isothermal process
- Non-isothermal process
- Combined process
- Bonding degree
- Summary and outlook





DIEHL AVIATION





Conventional sandwich structure:

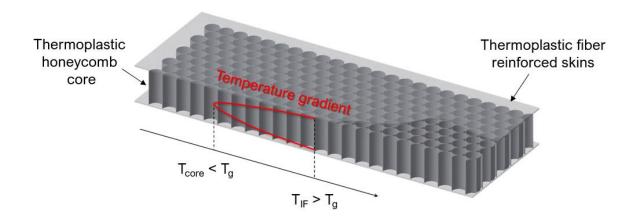
- phenolic/epoxy glass fiber reinforced prepregs
- aramid-phenolic resin paper honeycomb core (NOMEX®)





OBJECT AND CONCEPT

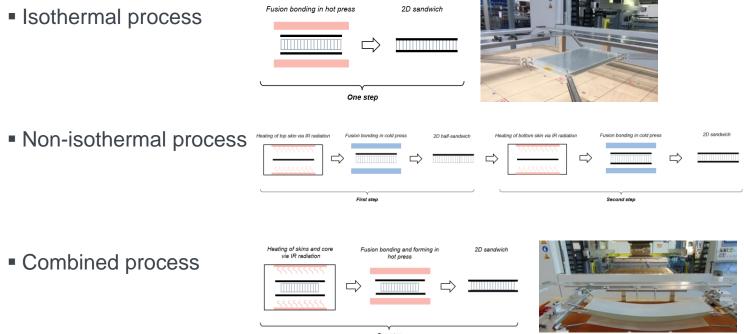
- obtain an adhesion-free thermoplastic sandwich panel
- <u>challenge</u>: to get a sufficient bonding degree between skins and honeycomb core by means of fusion bonding
- define optimal manufacturing process







MANUFACTURING PROCESS



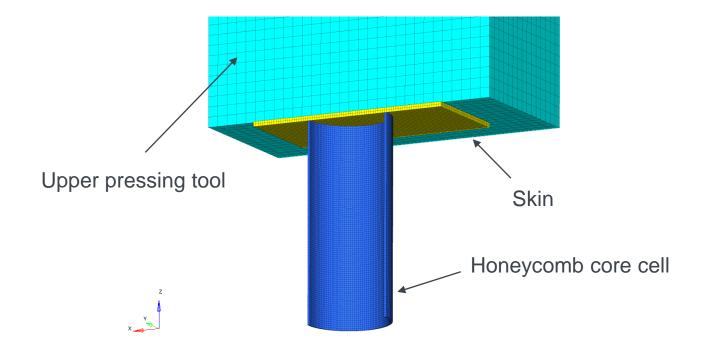
One step







NUMERICAL METHOD

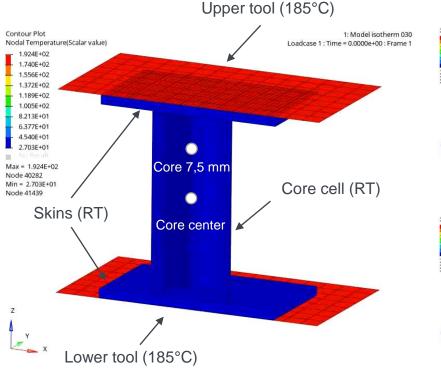


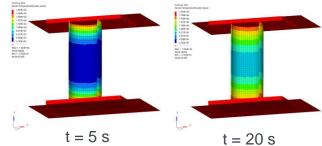


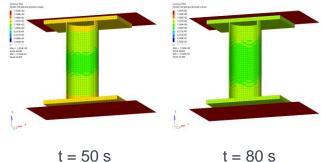


THERMOPLASTIC SANDWICH PANELS

ISOTHERMAL PROCESS



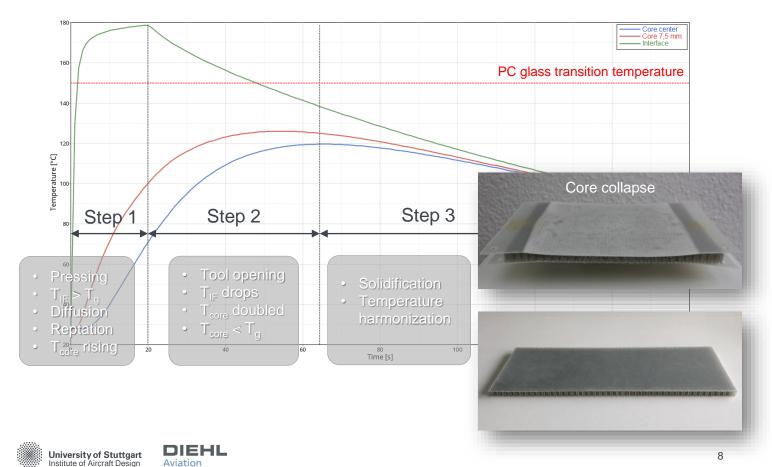




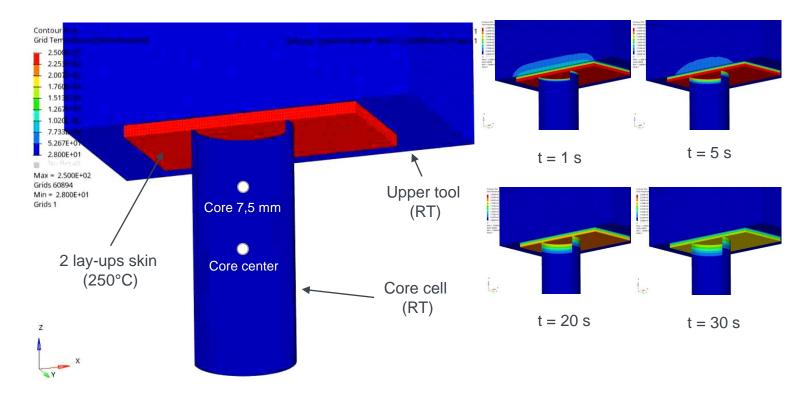




ISOTHERMAL PROCESS

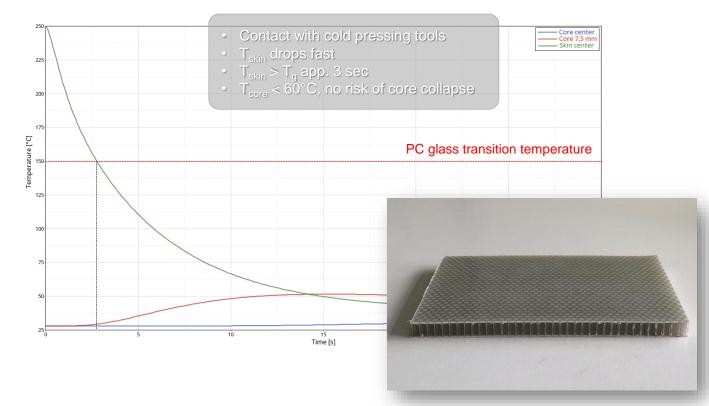






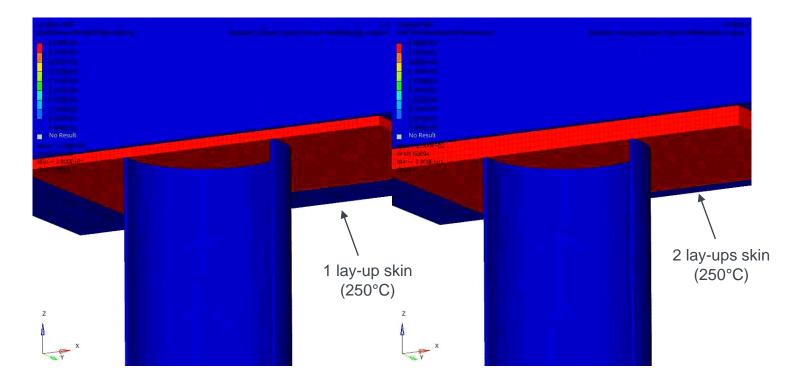






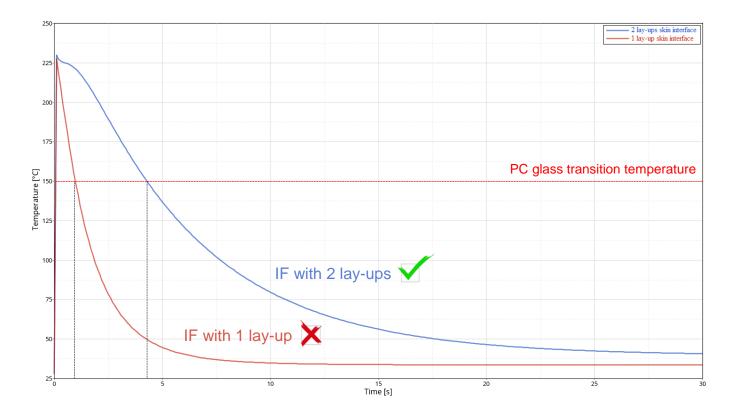






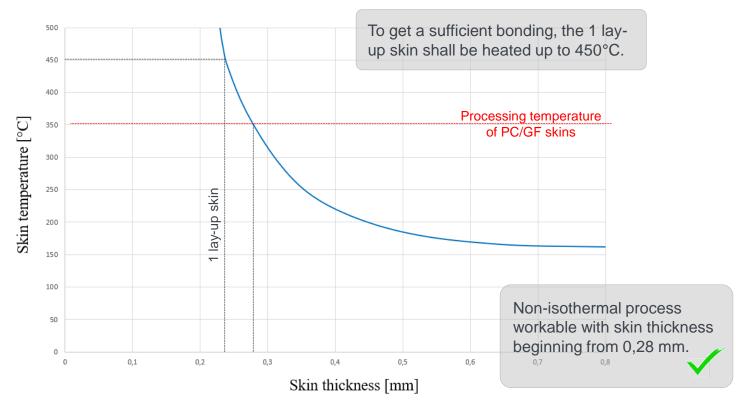










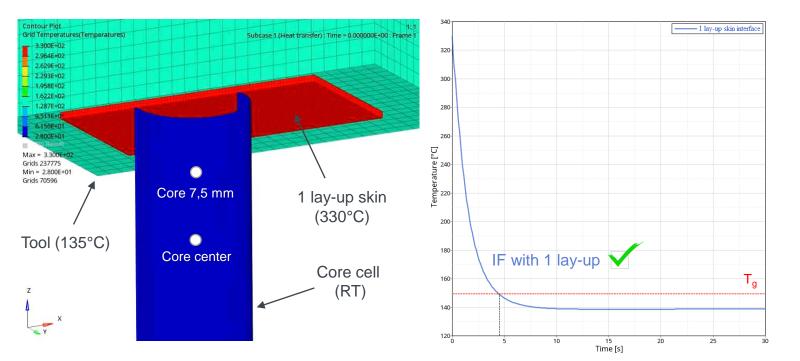






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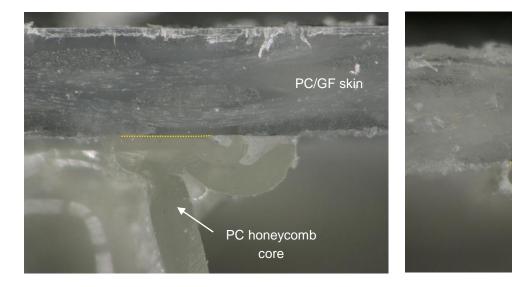
COMBINED PROCESS







MICROSCOPY



Isothermal process

- Core is partially melted and pressed
- · Domination of melted part
- Bonding degree is determined by contact surface

Non-isothermal process

- · Skin is heated
- Core penetration in softened skin
- · Partial melting of core
- Bonding degree is defined by penetration depth and contact surface





PC/GF skin

PC honeycomb core

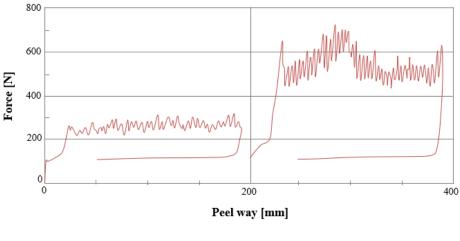


DRUM PEEL TEST





Drum peel test is conducted to determine the bonding quality between a face sheet and honeycomb core of the sandwich compound (ASTM D 1781).



Isothermal process Peel resistance 2 N/mm Non-isothermal process Peel resistance 6 N/mm





SUMMARY AND OUTLOOK

Thermal analysis

Definition of process window for:

- 1) Isothermal process
- 2) non-isothermal process (with restriction)
- 3) Combined process

Thermo-mechanical analysis

- 1) Mechanical behavior during thermoforming process
- 2) Failure modes prediction
- 3) Process window optimization









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Thank you!



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